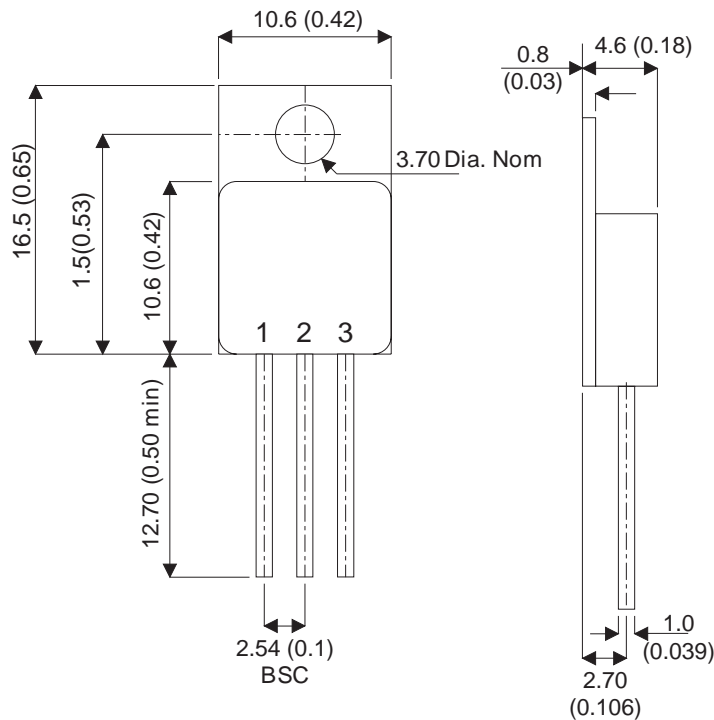




BUZ50A-220M BUZ50B-220M

MECHANICAL DATA

Dimensions in mm



MOS POWER N-CHANNEL ENHANCEMENT MODE TRANSISTORS

FEATURES

- HERMETIC TO220 ISOLATED METAL PACKAGE
- CECC SCREENING OPTIONS
- JAN LEVEL SCREENING OPTIONS

APPLICATIONS:

Hermetically sealed version for high reliability power linear and switching applications

TO220M (TO-257AB)- Isolated Metal Package

Pin 1 – Gate Pin 2 – Drain Pin 3 – Source

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}C$ unless otherwise stated)		BUZ50A	BUZ50B
V_{DS}	Drain – Source Voltage	1000V	1000V
V_{GS}	Gate – Source Voltage	$\pm 20V$	$\pm 20V$
I_D	Continuous Drain Current	1.0A	1.5A
I_{DM}	Maximum Pulsed Drain Current	4.0A	4.5A
P_D	Total Power Dissipation at $T_{case} \leq 25^{\circ}C$	75W	
T_{stg}	Storage Temperature Range	$-65^{\circ}C$ To $200^{\circ}C$	
T_j	Operating Junction Temperature Range	200°C	

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BUZ50A–220M BUZ50B–220M

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BV_{DSS} Drain – Source Breakdown Voltage	$V_{GS} = 0$ $I_D = 5.0\text{mA}$	1000			V
I_{DSS} Zero Gate Voltage Drain Current	$V_{DS} = 1000\text{V}$ $V_{GS} = 0\text{V}$ $T_J = 100^\circ\text{C}$			0.25	mA
				2.5	
I_{GSS} Gate – Body Leakage Current	$V_{GS} = 20\text{V}$ $V_{DS} = 0$			500	nA
$V_{GS(th)}$ * Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = 1.0\text{mA}$ $T_J = 100^\circ\text{C}$	2.0		4.5	V
		1.5		4.0	
$V_{DS(on)}$ * Drain Source On Voltage	$V_{GS} = 10\text{V}$ $I_D = 0.5\text{A}$ $T_J = 100^\circ\text{C}$			5.0	V
				10	
				12	
g_{fs} * Forward Transconductance	$V_{DS} = 15\text{V}$ $I_D = 0.5\text{A}$			0.5	S
$R_{DS(on)}$ * Drain – Source On–State Resistance*	$V_{GS} = 10\text{V}$ $I_D = 0.5\text{A}$			10	Ω
C_{iss} Input Capacitance	$V_{GS} = 0$			1200	pF
C_{oss} Output Capacitance	$V_{DS} = 25\text{V}$			300	
C_{rss} Reverse Transfer Capacitance	$f = 1\text{MHz}$			80	
$t_{d(on)}$ * Turn–On Delay Time	$T_J = 100^\circ\text{C}$ $I_D = 0.5\text{A}$			50	ns
t_r * Rise Time				150	
$t_{d(off)}$ * Turn–Off Delay Time	$V_{DS} = 125\text{V}$ $R_{gen} = 50\Omega$			200	
t_f * Fall Time				100	
SOURCE – DRAIN DIODE CHARACTERISTICS					
V_{SD} * Diode Forward Voltage	$I_S = 1.0\text{A}$ $V_{GS} = 0\text{V}$			1.0	V
t_{on} Forward Turn On Time				250	ns
t_{rr} Reverse Recovery Time				420	

NOTE: *Pulsed : Pulse duration = 300 μs , duty cycle $\leq 2\%$

THERMAL DATA

$R_{\theta JC}$ Thermal Resistance Junction – Case			1.67	$^\circ\text{C/W}$
$R_{\theta JA}$ Thermal Resistance Junction – Ambient			75	

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